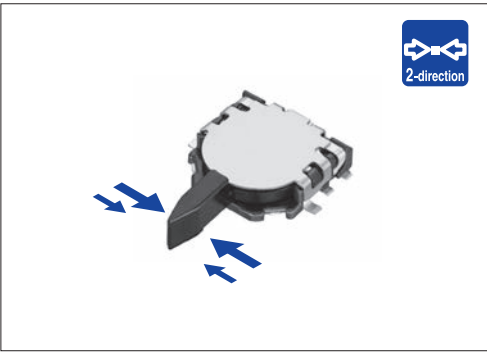


Industry's smallest two-step detector switch takes up 30% less space than existing products



Typical Specifications

Items		Specifications
Rating (max.)/(min.) (Resistive load)		1mA 5V DC / 50μA 3V DC
Contact resistance (Initial / After operating life)		2Ω max. / 5Ω max.
Operating force		0.35N max.
Operating life	Without load	50,000cycles
	With load	50,000cycles (1mA 5V DC)

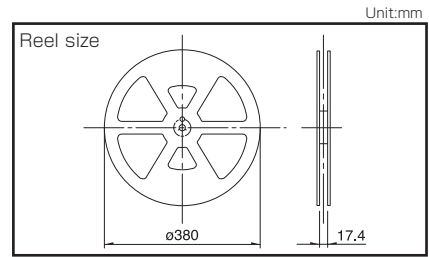
Product Line

Poles	Positions	Terminal type	Total travel (mm)	Location lug	Minimum order unit (pcs.)		Product No.
					Japan	Export	
1	Two-direction type : 2-position each side	For PC board (Reflow)	3.73	With	4,000	16,000	SSCQ110100
				Without			SSCQ120102

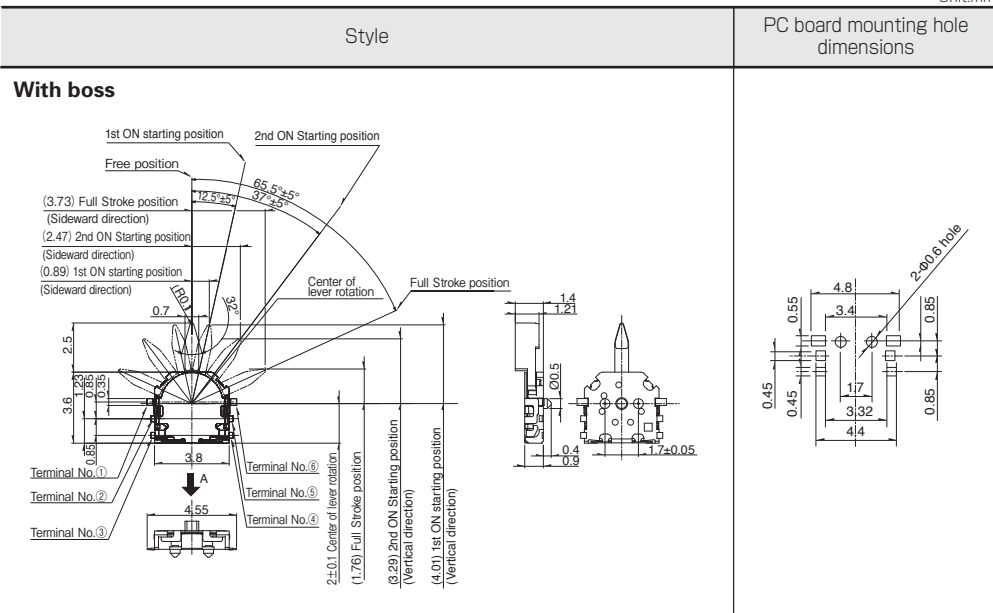
Packing Specifications

Taping

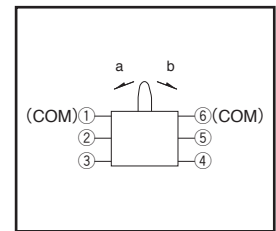
Number of packages (pcs.)			Tape width (mm)	Export package measurements (mm)
1 reel	1 case / Japan	1 case / export packing		
4,000	8,000	16,000	16	417×409×139



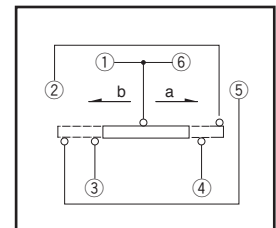
Dimensions



Terminal Layout



Circuit Diagram



Note

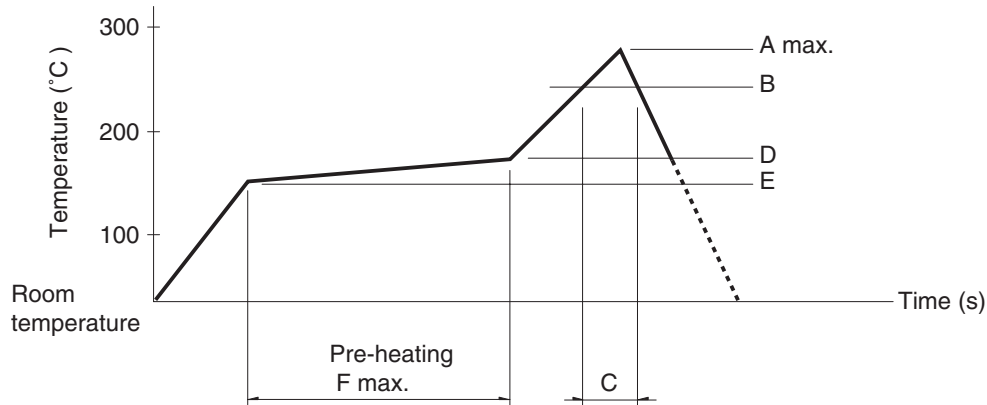
Dimensions drawing is for type with location lugs.

Refer to P.71 for soldering conditions.

Detector Switches Soldering Conditions

Example of Reflow Soldering Condition

1. Heating method: Double heating method with infrared heater.
2. Temperature measurement: Thermocouple $\phi 0.1$ to 0.2 CA (K) or CC (T) at soldering portion (copper foil surface).
A heat resisting tape should be used for fixed measurement.
3. Temperature profile



Series (Reflow type)	A (°C) 3s max.	B (°C)	C (s)	D (°C)	E (°C)	F (s)
SPPB	250	230	40	180	150	120
SPPW8			35			
SPVE	260		40			
SPVL						
SPVM						
SPVN						
SPVR						
SPVS						
SPVT						
SSCM						
SSCQ						
SPVQC	250					

Notes

1. The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, surface depending on the PC board's material, size, thickness, etc.
The above-stated conditions shall also apply to switch surface temperatures.
2. Soldering conditions differ depending on reflow soldering machines.
Prior verification of soldering condition is highly recommended.

Reference for Hand Soldering

Series	Soldering temperature	Soldering time
SPVS, SPVN, SPVT, SPVM, SPVR, SPVE, SPPW8, SSCQ, SSCM, SPVL, SSCT, SPVQC	350±5°C	3s max.
SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SSCN, SPVQA	300±10°C	3 +1 / 0s
SPPB (Reflow)	300±5°C	5s max.
SSCF, SPPB (For Lead, Dip)	350±10°C	3 +1 / 0s

Reference for Dip Soldering

(For PC board terminal types)

Series	Items		Dip soldering	
	Preheating temperature	Preheating time	Soldering temperature	Duration of immersion
SSCT, SPVQ1, SPVQ3, SPVQ6, SPVQ7, SPVQ8, SPVQ9, SPVQA	100±10°C	60s max.	260±5°C	5±1s
SPPW8, SPPB	100 °C max.	60s max.	255±5°C	5±1s
SSCF	—		260±5°C	5±1s